

PATENT ASSIGNMENT COVER SHEET

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Property Type	Number
Application Number:	15031575
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DATE SIGNED:	04/22/2016
Total Attachments: 2 source=3560_Assignment#page1.tif source=3560_Assignment#page2.tif	

ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to the undersigned by NATIONAL UNIVERSITY CORPORATION HOKKAIDO UNIVERSITY A corporation organized under the laws of Japan and located at Kita 8-jyo Nishi 5-chome, Kita-ku, Sapporo-shi, Hokkaido 060-0808 JAPAN and JAPAN SCIENCE AND TECHNOLOGY AGENCY A corporation organized under the laws of Japan and located at 4-1-8, Honcho, Kawaguchi-shi, Saitama 332-0012 Japan receipt of which is hereby acknowledged, I or we do hereby sell and assign to said NATIONAL UNIVERSITY CORPORATION HOKKAIDO UNIVERSITY and JAPAN SCIENCE AND TECHNOLOGY AGENCY their successors and assigns, all of my or our right, title and interest, in and for the United States of America in and to the invention entitled

GROUP III-V COMPOUND SEMICONDUCTOR NANOWIRE, FIELD EFFECT TRANSISTOR, AND SWITCHING ELEMENT

invented by me or us and described in the application for U.S. Letters Patent therefor identified as:

(X) Serial No. PCT/JP2014/005463 , filed October 29, 2014 ; or

() executed on even date herewith; or

() executed on (date) _____ ,

and all United States Letters Patent which may be granted therefor, and all Divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by NATIONAL UNIVERSITY CORPORATION HOKKAIDO UNIVERSITY and JAPAN SCIENCE AND TECHNOLOGY AGENCY their successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by the me or us if this assignment and sale had not been made;

And I or we hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reexamination or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the joint title thereto in said assignees;

And I or we do hereby authorize and request the Commissioner of Patents and Trademarks, or equivalent, to issue said Letters Patent to said NATIONAL UNIVERSITY CORPORATION HOKKAIDO UNIVERSITY and JAPAN SCIENCE AND TECHNOLOGY AGENCY and do hereby authorize the Law Firm of Brundidge & Stanger, P.C. to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

Date Signed

1) Takashi Fukui
Takashi FUKUI

January 28, 2016

2) Katsuhiro Tomioaka
Katsuhiro TOMIOKA

28th, Jan. 2016